

## 30V 90A N-Channel Enhancement Mode Power MOSFET

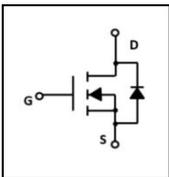
### Features

- $R_{DS(on)} \leq 4.7m\Omega$  @ $V_{gs}=10V$
- Advanced trench technology
- Excellent  $R_{DS(on)}$  and Low Gate Charge
- Lead free product is acquired

### Application

- Load Switch
- PWM Application
- Power management

### SYMBOL



TO-252

### ASSEMBLY MESSAGE

Product Name	Package	Packaging
BXT047N03D	TO-252	Reel

### ABSOLUTE MAXIMUM RATINGS ( $T_C=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Rating	Unit	
		TO-252		
Drain-Source Voltage	$V_{DSS}$	30	V	
Drain Current	Continuous ( $T_C = 25^\circ C$ )	$I_D$	90	A
			Continuous ( $T_C = 100^\circ C$ )	60
Drain Current	Pulsed (Note1)	$I_{DM}$	360	A
Single Pulsed Avalanche Energy	EAS	198	mJ	
Gate-Source Voltage	$V_{GSS}$	$\pm 20$	V	
Power Dissipation	$T_C = 25^\circ C$	$P_D$	64	W
Maximum Junction Temperature	$T_J$	150	$^\circ C$	
Storage Temperature Range	$T_{STG}$	-55 to 150	$^\circ C$	

Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

### THERMAL CHARACTERISTICS

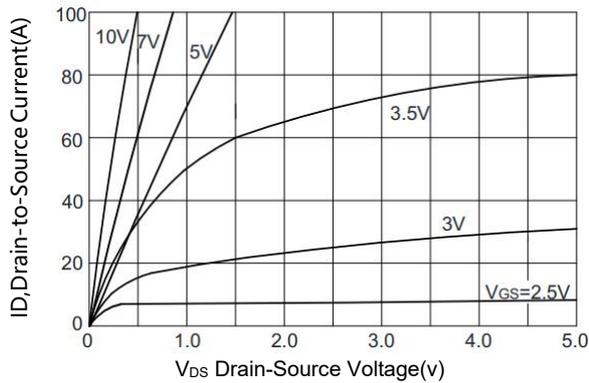
Parameter	Symbol	Max.	Unit
		TO-252	
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.95	$^\circ C / W$

**ELECTRICAL CHARACTERISTICS** (T<sub>J</sub>=25°C, unless otherwise Noted)

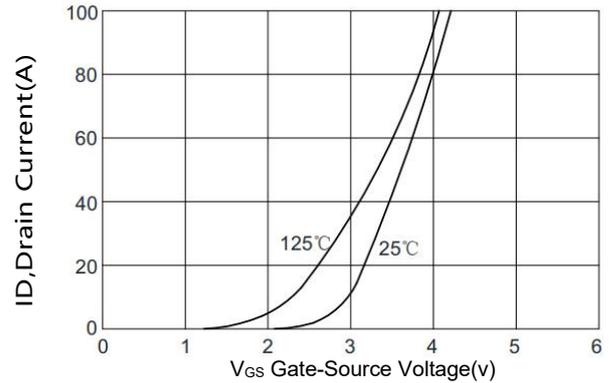
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	VGS=0V, ID=250μA	30			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	VDS=30V, VGS=0V			1	μA
Gate-Body Leakage Current, Forward	I <sub>GSS</sub>	VGS=20V			100	nA
Gate-Body Leakage Current, Reverse		VGS=-20V			-100	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	VDS=VGS, ID=250μA	1	1.5	2.5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	VGS=10V, ID=30A		3.5	4.7	mΩ
		VGS=4.5V, ID=20A		7	10	mΩ
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	C <sub>ISS</sub>	VDS=15V, VGS=0V, f=1.0MHz		2089		pF
Output Capacitance	C <sub>OSS</sub>			321		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			290		pF
<b>SWITCHING PARAMETERS</b>						
Turn-ON Delay Time	t <sub>D(ON)</sub>	VDD=15V, ID=30A, VGS = 10V, RG=3Ω		22		ns
Turn-ON Rise Time	t <sub>R</sub>			31		ns
Turn-OFF Delay Time	t <sub>D(OFF)</sub>			61		ns
Turn-OFF Fall-Time	t <sub>F</sub>			35		ns
Total Gate Charge(Note2)	Q <sub>G</sub>	VDS =15V, VGS =10V, ID=30A		46		nC
Gate Source Charge	Q <sub>GS</sub>			4		nC
Gate Drain Charge	Q <sub>GD</sub>			13		nC
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =30A, VGS=0V			1.4	V
Diode Continuous Forward Current	I <sub>S</sub>				90	A
Maximum Pulsed Drain to Source Diode Forward Current	I <sub>SM</sub>				360	A

Note: 2. Essentially independent of operating temperature

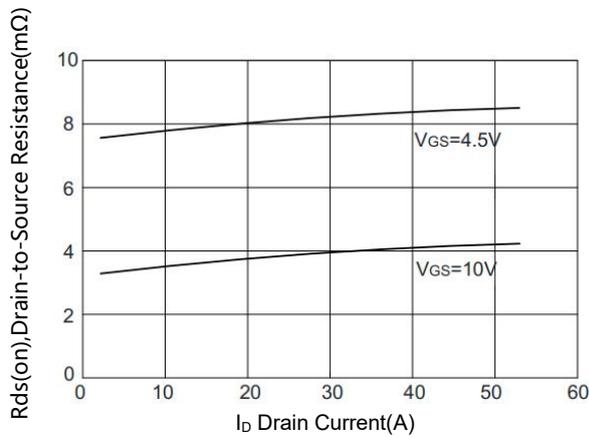
**TYPICAL CHARACTERISTICS**



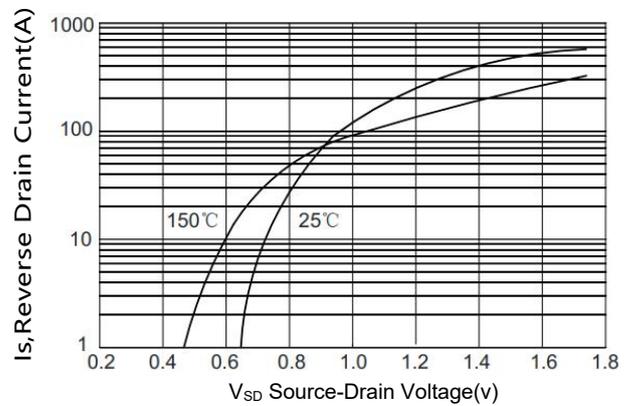
**Figure1. Typical Output Characteristics**



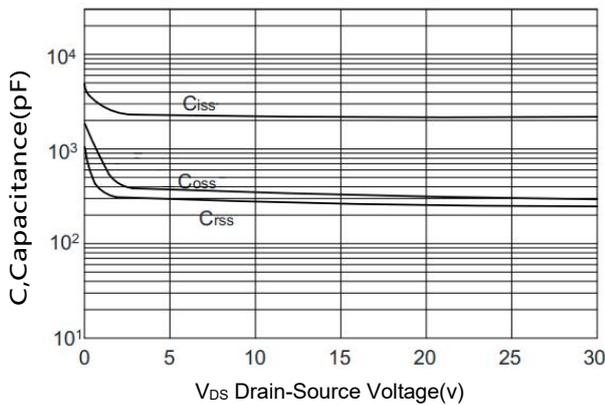
**Figure2. Typical Transfer Characteristics**



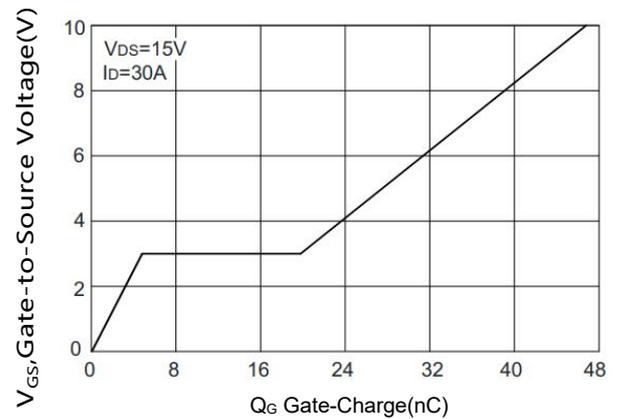
**Figure3. On-Resistance versus Drain Current**



**Figure4. Diode forward voltage versus Current**

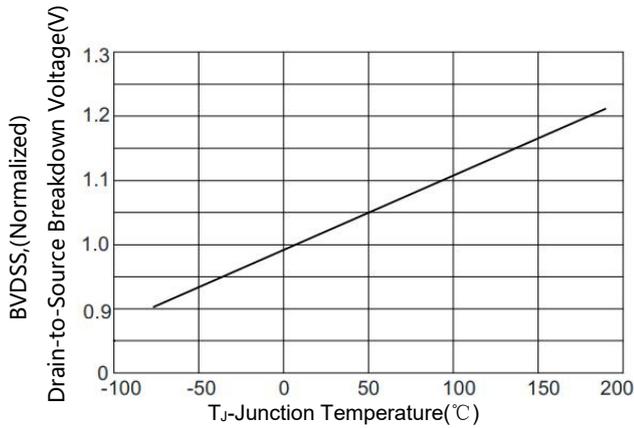


**Figure5. Typical Capacitance versus VDS**

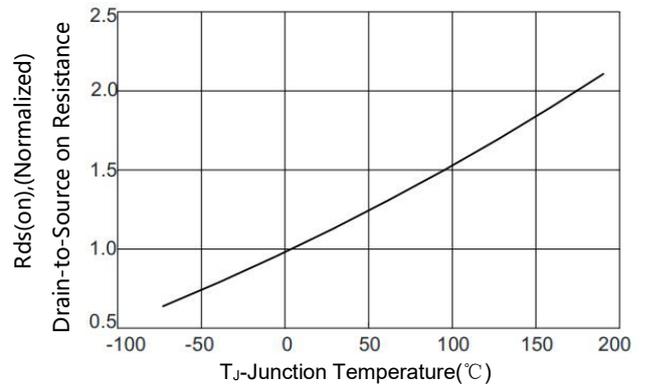


**Figure6. Typical Gate Charge versus VGS**

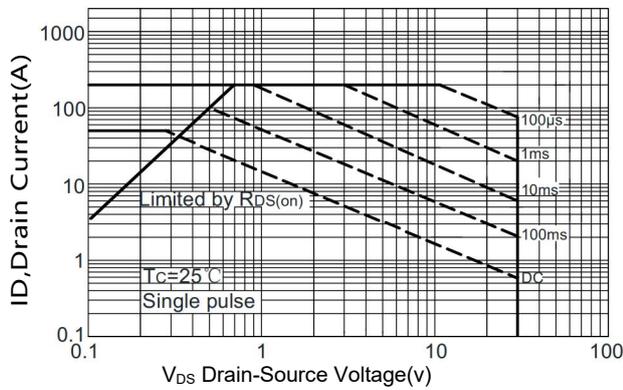
**TYPICAL CHARACTERISTICS(Cont.)**



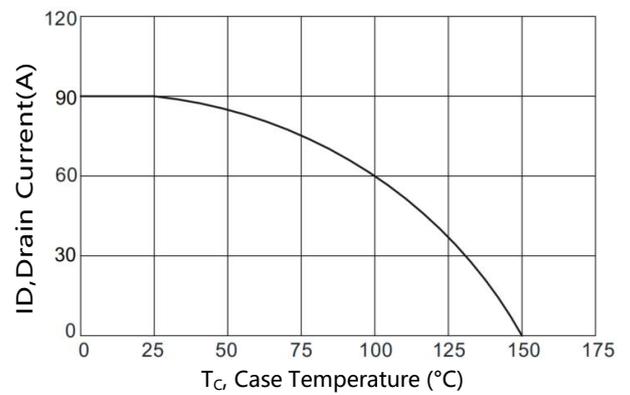
**Figure7. BV<sub>DSS</sub> Variation with Temperature**



**Figure8. On-Resistance Variation with Temperature**

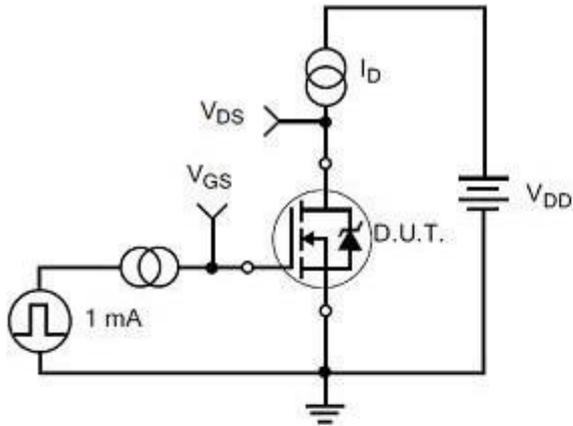


**Figure9. Maximum Safe Operating Area**

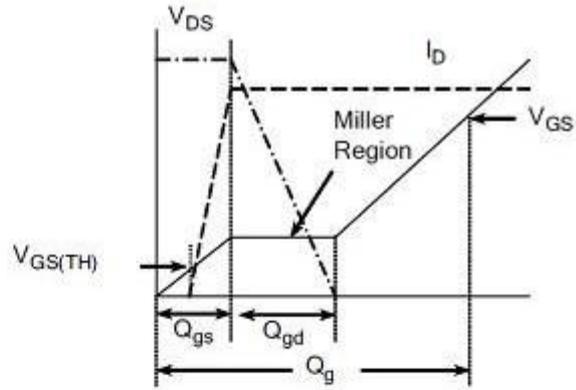


**Figure10. Maximum Continuous Drain Current versus Case Temperature**

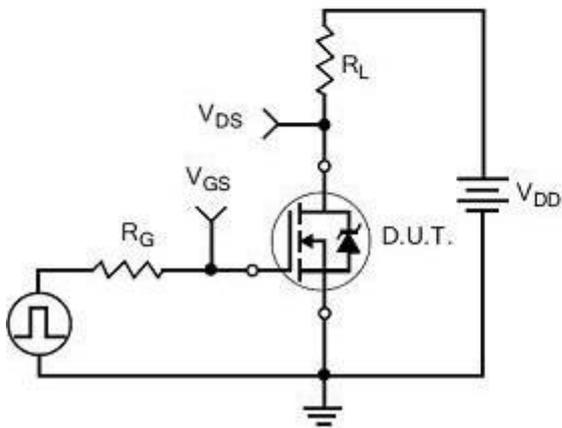
TEST CIRCUITS AND WAVEFORMS



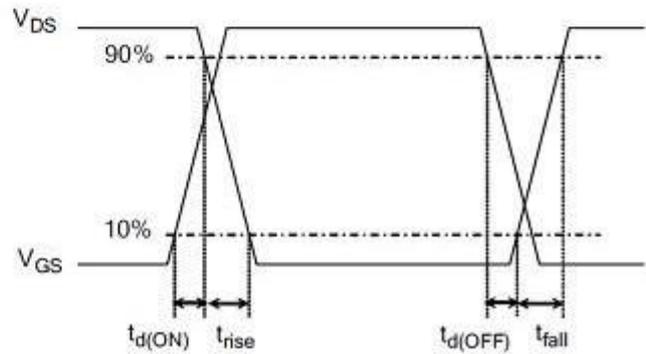
Gate Charge Test Circuit



Gate Charge Waveform

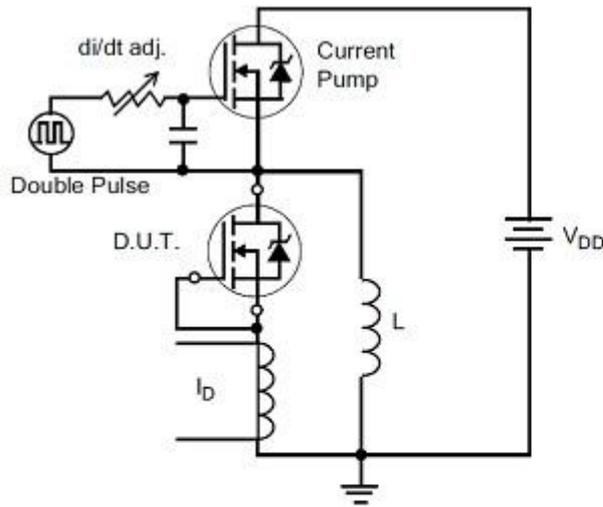


Resistive Switching Test Circuit

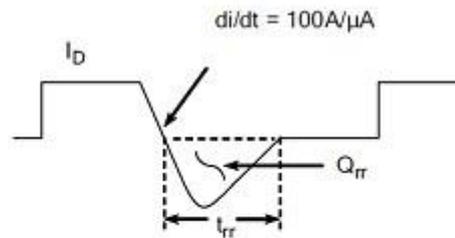


Resistive Switching Waveforms

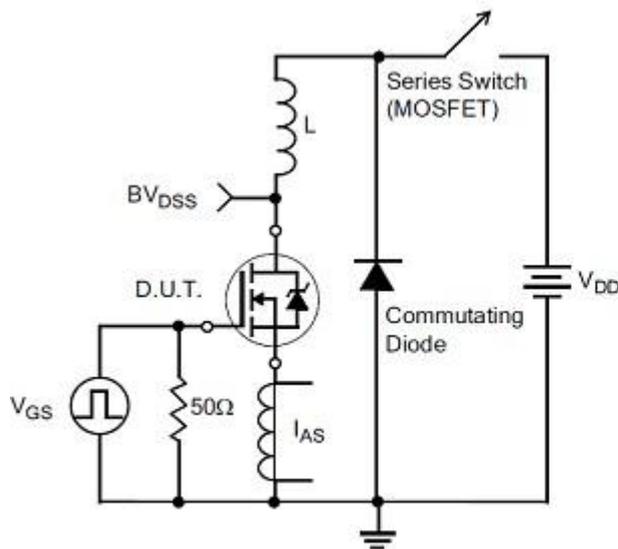
TEST CIRCUITS AND WAVEFORMS(Cont.)



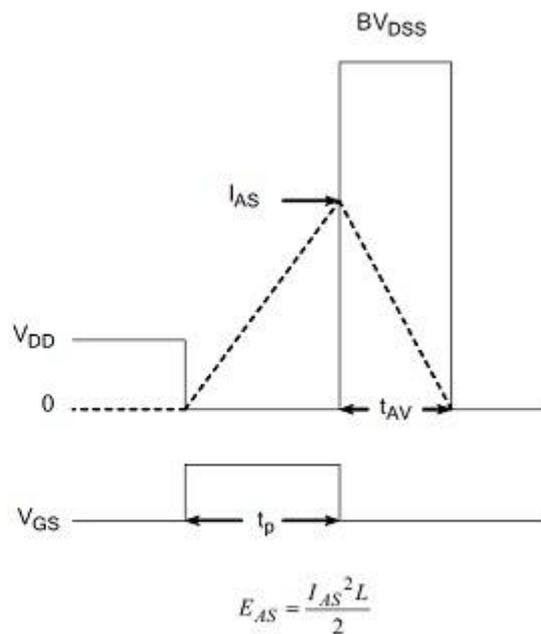
Diode Reverse Recovery Test Circuit



Diode Reverse Recovery Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

**Revision history****Document revision history**

<b>Date</b>	<b>Revision</b>	<b>Changes</b>
26-Oct-2021	1.0	First release

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